

# Single P-channel MOSFET

## ELM14427AA-N

### ■General description

ELM14427AA-N uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and low gate resistance. Internal ESD protection is included.

### ■Features

- $V_{ds} = -30V$
- $I_d = -12.5A$  ( $V_{gs} = -20V$ )
- $R_{ds(on)} < 12m\Omega$  ( $V_{gs} = -20V$ )
- $R_{ds(on)} < 14m\Omega$  ( $V_{gs} = -10V$ )
- ESD Rating : 2000V HBM

### ■Maximum absolute ratings

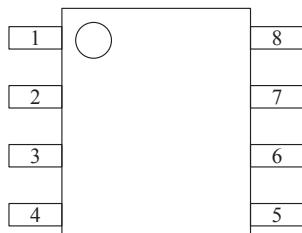
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	-30	V	
Gate-source voltage	$V_{gs}$	$\pm 25$	V	
Continuous drain current Ta=25°C	$I_d$	-12.5	A	1
Ta=70°C	$I_d$	-10.5		
Pulsed drain current	$I_{dm}$	-60	A	2
Power dissipation Ta=25°C	$P_d$	3.0	W	1
Ta=70°C	$P_d$	2.1		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

### ■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	$R_{\theta ja}$	28	40	°C/W	1
Maximum junction-to-ambient	Steady-state		54	75	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	21	30	°C/W	3

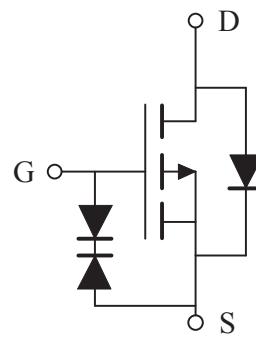
### ■Pin configuration

SOP-8(TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

### ■Circuit



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### ■Electrical characteristics

T<sub>a</sub>=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	BV <sub>dss</sub>	I <sub>d</sub> =-250μA, V <sub>gs</sub> =0V	-30			V
Zero gate voltage drain current	I <sub>dss</sub>	V <sub>ds</sub> =-24V			-1	μA
		V <sub>gs</sub> =0V	T <sub>j</sub> =55°C		-5	
Gate-body leakage current	I <sub>gss</sub>	V <sub>ds</sub> =0V, V <sub>gs</sub> =±25V			±1	μA
Gate threshold voltage	V <sub>gs(th)</sub>	V <sub>ds</sub> =V <sub>gs</sub> , I <sub>d</sub> =-250μA	-1.7	-2.5	-3.0	V
On state drain current	I <sub>d(on)</sub>	V <sub>gs</sub> =-10V, V <sub>ds</sub> =-5V	-60			A
Static drain-source on-resistance	R <sub>ds(on)</sub>	V <sub>gs</sub> =-20V		9.4	12.0	mΩ
		I <sub>d</sub> =-12.5A	T <sub>j</sub> =125°C	12.2	15.0	
		V <sub>gs</sub> =-10V, I <sub>d</sub> =-10A		11.5	14.0	mΩ
		V <sub>gs</sub> =-4.5V, I <sub>d</sub> =-5A		32.0		mΩ
Forward transconductance	G <sub>fs</sub>	V <sub>ds</sub> =-5V, I <sub>d</sub> =-12.5A		24		S
Diode forward voltage	V <sub>sd</sub>	I <sub>s</sub> =-1A, V <sub>gs</sub> =0V			-1	V
Max. body-diode continuous current	I <sub>s</sub>				-4.2	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	C <sub>iss</sub>	V <sub>gs</sub> =0V, V <sub>ds</sub> =-15V, f=1MHz		2330	2900	pF
Output capacitance	C <sub>oss</sub>			480		pF
Reverse transfer capacitance	C <sub>rss</sub>			320		pF
Gate resistance	R <sub>g</sub>	V <sub>gs</sub> =0V, V <sub>ds</sub> =0V, f=1MHz		6.8	10.0	Ω
<b>SWITCHING PARAMETERS</b>						
Total gate charge	Q <sub>g</sub>	V <sub>gs</sub> =-10V, V <sub>ds</sub> =-15V I <sub>d</sub> =-12.5A		41	52	nC
Gate-source charge	Q <sub>gs</sub>			10		nC
Gate-drain charge	Q <sub>gd</sub>			12		nC
Turn-on delay time	t <sub>d(on)</sub>	V <sub>gs</sub> =-10V, V <sub>ds</sub> =-15V R <sub>l</sub> =1.2Ω, R <sub>gen</sub> =3Ω		12.8		ns
Turn-on rise time	t <sub>r</sub>			10.3		ns
Turn-off delay time	t <sub>d(off)</sub>			49.5		ns
Turn-off fall time	t <sub>f</sub>			29.0		ns
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>f</sub> =-12.5A, dI/dt=100A/μs		28	35	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>f</sub> =-12.5A, dI/dt=100A/μs		20		nC

#### NOTE :

1. The value of R<sub>θja</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with T<sub>a</sub>=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R<sub>θja</sub> is the sum of the thermal impedance from junction to lead R<sub>θjl</sub> and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>a</sub>=25°C. The SOA curve provides a single pulse rating.



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## ■ Typical electrical and thermal characteristics

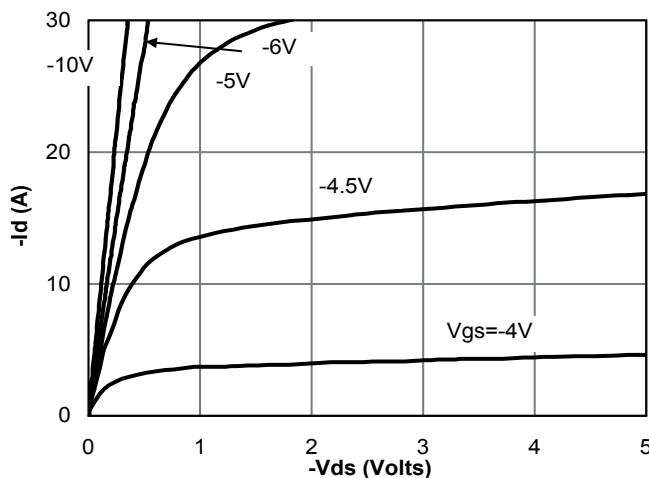


Fig 1: On-Region Characteristics

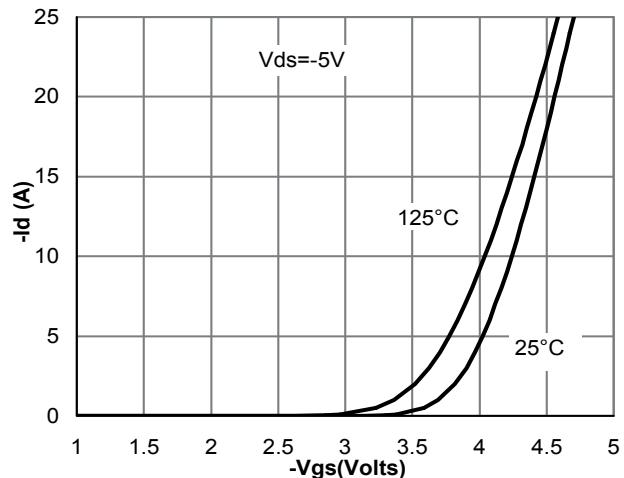


Figure 2: Transfer Characteristics

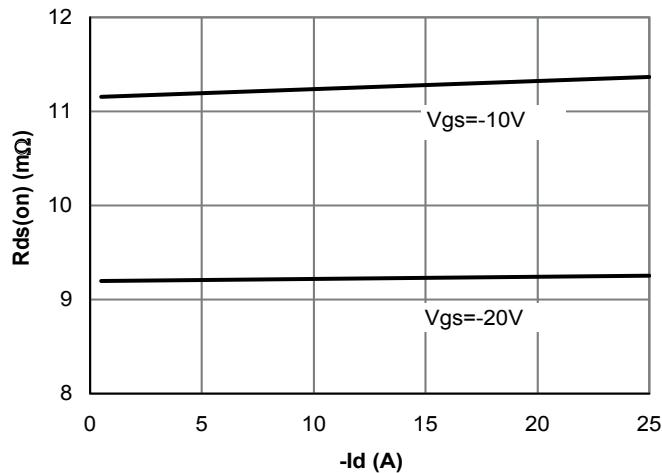


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

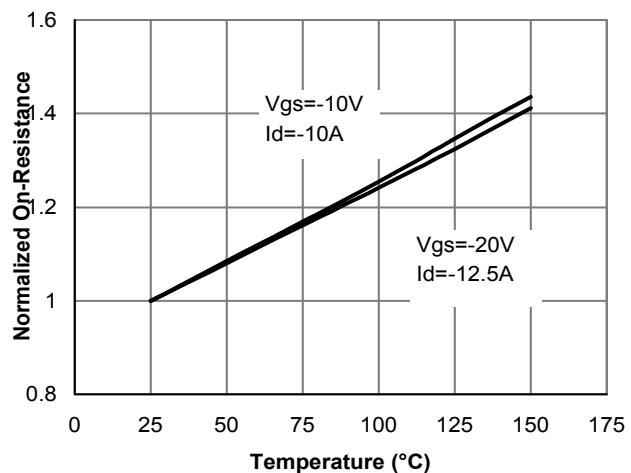


Figure 4: On-Resistance vs. Junction Temperature

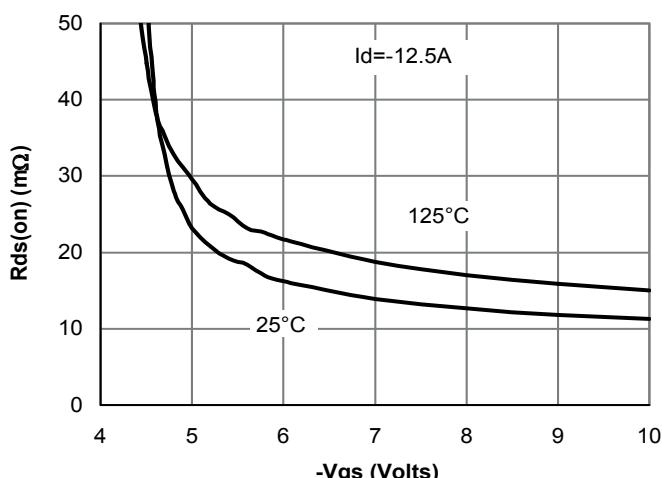


Figure 5: On-Resistance vs. Gate-Source Voltage

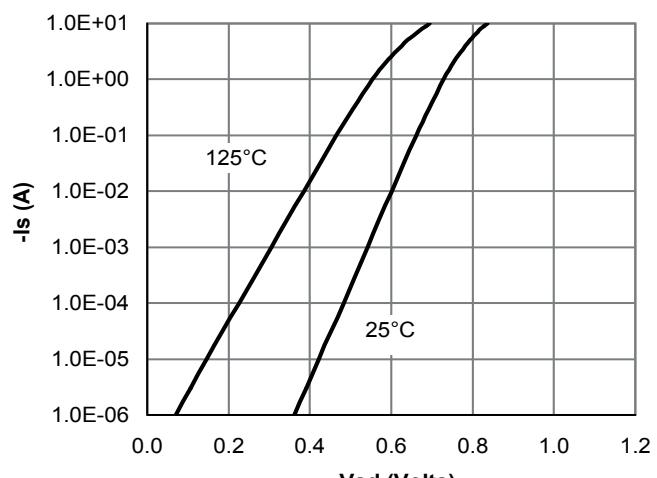


Figure 6: Body-Diode Characteristics

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